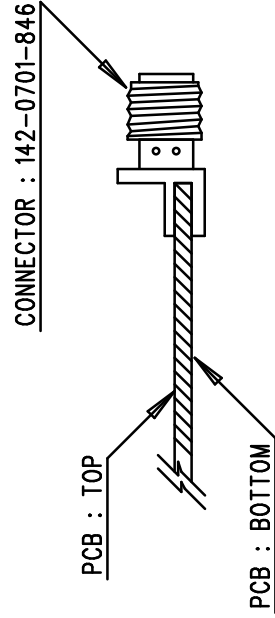
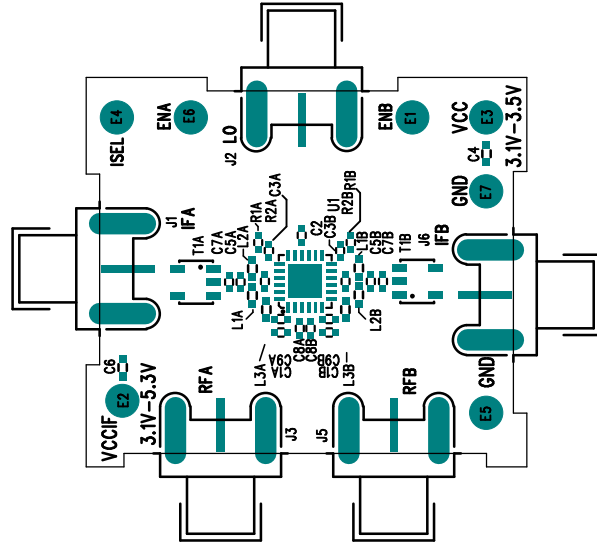


1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
5. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP



APPROVALS		1630 MCCARTHY BLVD MILPITAS, CA 95035 PH: (408)432-1900 www.linear.com LTC CONFIDENTIAL- FOR CUSTOMER USE ONLY			
PCB DES.	JW	TITLE: TOP ASSEMBLY DRAWING DUAL HIGH DYNAMIC RANGE DOWN CONVERTING MIXER			
APP ENG.	VLAD. D.				
		SIZE	IC NO.	LTC559XIUH	REV.
		N/A		DEMO CIRCUIT 1710A	2
SCALE = NONE		FILENAME:		1710A-2.PCB	SHT 1 OF 2